

## MAX8863/64 Pin Compatible, Low Dropout, 120 mA Linear Regulators

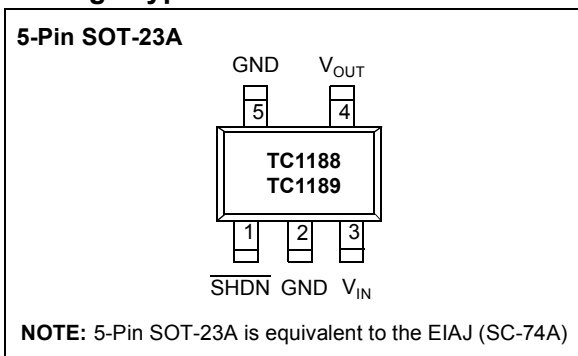
### Features

- Input Voltage Range: 2.7 V to 6.0 V
- 120 mA Output Current
- Low Supply Current: 50  $\mu$ A, (typical)
- Low Dropout Voltage: 110 mV, (typical at 100 mA)
- Fast Turn-On from Shutdown: 140  $\mu$ sec (typical)
- Low Output Noise
- Over-Current and Over-Temperature Protection
- Low Power Shutdown Mode
- Auto Discharge of Output Capacitor (TC1189)

### Applications

- Battery Powered Systems
- Portable Computers
- Medical Instruments
- Cellular, Cordless Phones
- PDAs
- Pagers

### Package Type



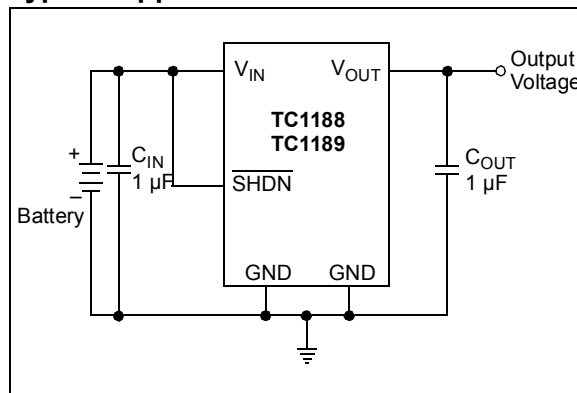
### General Description

The TC1188 and TC1189 are fixed output, low dropout linear regulators that operate from a 2.7V to 6.0V input voltage source. The output is capable of delivering up to 120 mA while consuming only 50  $\mu$ A of quiescent current. The low dropout voltage, 120 mV, make the TC1188 and TC1189 good choices for battery powered applications. Integrated over-current and over-temperature protection features provide for a fault tolerant solution.

The TC1189 includes an output voltage auto discharge feature. When shutdown, the TC1189 will automatically discharge the output voltage using an internal N-Channel MOSFET switch.

Fixed output voltage options for the TC1188/TC1189 are: 1.80V, 2.80V, 2.84V and 3.15V. Both the TC1188 and TC1189 are available in SOT23-5 packages.

### Typical Application Circuit



# TC1188/TC1189

## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings\*

Input Voltage .....	6.5V
Output Short-Circuit Duration .....	Infinite
Output Voltage .....	(-0.3V) to ( $V_{IN} + 0.3V$ )
Maximum Voltage On Any Pin....	(-0.3V) to ( $V_{IN} + 0.3V$ )
Continuous Power Dissipation ( $T_A = +70^\circ\text{C}$ )	
SOT-23-5 (derate 7.1 mW/°C above +70°C)	
.....	571 mW
Operating Temperature Range.....	-40°C to 85°C
Storage Temperature .....	-65°C to +160°C
Lead Temperature (Soldering, 10 Sec.) .....	+300°C

**\*Notice:** \*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### DC SPECIFICATIONS

Electrical Characteristics: $V_{IN} = +3.6V$ , $GND = 0V$ , $T_A = T_{MIN}$ to $T_{MAX}$ , unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$ . (Note 1)						
Parameters	Symbol	Min	Typ	Max	Units	Conditions
Input Voltage	$V_{IN}$	$V_{OUT} + 0.5V$ 2.7	—	6.0 6.0	V	$V_{OUT} \geq 2.5V$ $V_{OUT} = 1.8V$ (Note 2)
Output Voltage	$V_{OUT}$	3.05	3.15	3.25	V	$0\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$ T
		2.75	2.84	2.93	V	$0\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$ S
		2.70	2.80	2.88	V	$0\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$ R
		1.745	1.80	1.85	V	$0\text{ mA} \leq I_{OUT} \leq 50\text{ mA}$ Q
Maximum Output Current	$I_{OUT}$	120	—	—	mA	
Current Limit	$I_{LIM}$	—	280	—	mA	Note 3
Input Current	$I_{IN}$	—	50	90	$\mu\text{A}$	$I_{OUT} = 0$
Dropout Voltage		—	1.1	—	mV	$I_{OUT} = 1\text{ mA}$
		—	55	120	mV	$I_{OUT} = 50\text{ mA}$
		—	110	240	mV	$I_{OUT} = 100\text{ mA}$ (Note 4)
Line Regulation	$\Delta V_{LNR}$	-0.10	0.001	0.10	%/V	$V_{IN} = V_{OUT} + 0.5V$ to $6.0V$
		—	—	—	%/V	$I_{OUT} = 1\text{ mA}$
Load Regulation	$\Delta V_{LDR}$	—	0.01	0.040	%/mA	$I_{OUT} = 0\text{ mA}$ to $50\text{ mA}$
Output Voltage Noise		—	350	—	$\mu\text{V}_{RMS}$	10 Hz to 1 MHz, $C_{OUT} = 1\text{ }\mu\text{F}$
		—	220	—	$\mu\text{V}_{RMS}$	10 Hz to 1 MHz $C_{OUT} = 100\text{ }\mu\text{F}$
Wake Up Time (from Shutdown Mode)	$t_{WK}$	—	10	—	$\mu\text{sec}$	$V_{IN} = 3.6V$ $C_{IN} = 1\text{ }\mu\text{F}$ , $C_{OUT} = 1\text{ }\mu\text{F}$ $I_L = 30\text{ mA}$ , (See Figure 3-1)
Setting Time (from Shutdown Mode)	$t_S$	—	140	—	$\mu\text{sec}$	$V_{IN} = 3.6V$ $C_{IN} = 1\text{ }\mu\text{F}$ , $C_{OUT} = 1\text{ }\mu\text{F}$ $I_L = 30\text{ mA}$ , (See Figure 3-1)

- Note 1:** Limits are 100% production tested at  $T_A = +25^\circ\text{C}$ . Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods.
- Note 2:** Validated by line regulation test.
- Note 3:** Not tested. For design purposes, the current limit should be considered 150 mA minimum to 410 mA maximum.
- Note 4:** The dropout voltage is defined as ( $V_{IN} - V_{OUT}$ ) when  $V_{OUT}$  is 100 mV below the value of  $V_{OUT}$  for  $V_{IN} = V_{OUT} + 2V$ .

## DC SPECIFICATIONS (CONTINUED)

**Electrical Characteristics:**  $V_{IN} = +3.6V$ ,  $GND = 0V$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ C$ . (Note 1)

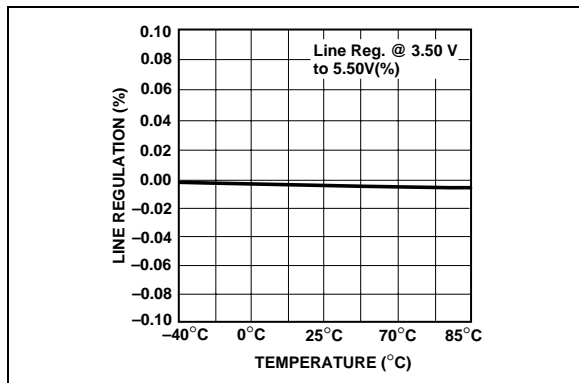
Parameters	Symbol	Min	Typ	Max	Units	Conditions
<b>Shutdown:</b>						
SHDN Input Threshold	$V_{IH}$	2.0	—	—	V	
	$V_{IL}$	—	—	0.4	V	
SHDN Input Bias Current	$I_{shdn}$	—	0.1	100	nA	$V_{SHDN} = V_{IN}$ , $T_A = +25^\circ C$ , $T_A = T_{MAX}$
		—	50	—	nA	$V_{SHDN} = V_{IN}$ , $T_A = +25^\circ C$ , $T_A = T_{MAX}$
Shutdown Supply Current	$I_{qshdn}$	—	0.002	1	$\mu A$	$V_{OUT} = 0V$ , $T_A = +25^\circ C$ , $T_A = T_{MAX}$
		—	0.02	—	$\mu A$	$V_{OUT} = 0V$ , $T_A = +25^\circ C$ , $T_A = T_{MAX}$
Shutdown to Output Discharge Delay (TC1189)		—	1	—	msec	$C_{OUT} = 1 \mu F$ , no load at 10% of $V_{OUT}$
<b>Thermal Protection</b>						
Thermal Shutdown Temperature	$T_{SHDN}$	—	170	—	$^\circ C$	
Thermal Shutdown Hysteresis	$\Delta T_{SHDN}$	—	20	—	$^\circ C$	

- Note 1:** Limits are 100% production tested at  $T_A = +25^\circ C$ . Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods.
- 2:** Validated by line regulation test.
- 3:** Not tested. For design purposes, the current limit should be considered 150 mA minimum to 410 mA maximum.
- 4:** The dropout voltage is defined as  $(V_{IN} - V_{OUT})$  when  $V_{OUT}$  is 100 mV below the value of  $V_{OUT}$  for  $V_{IN} = V_{OUT} + 2V$ .

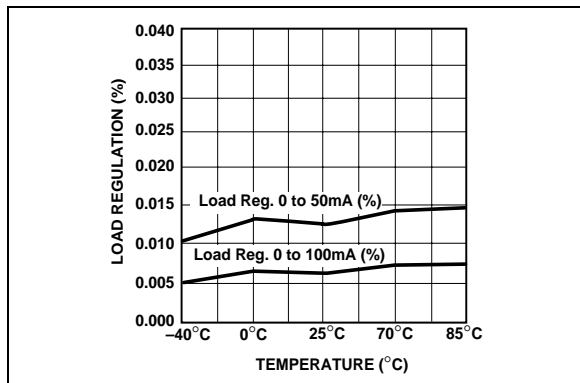
# TC1188/TC1189

## 2.0 TYPICAL PERFORMANCE CURVES

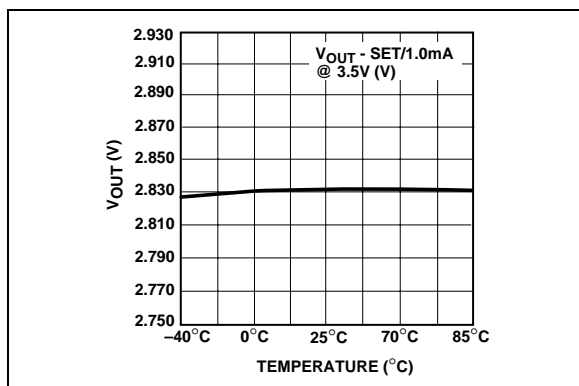
**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



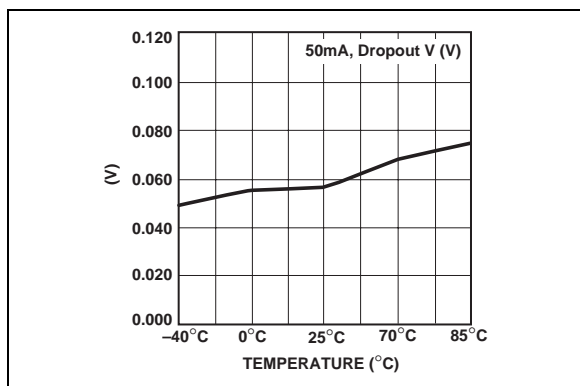
**FIGURE 2-1:** Line Regulation vs. Temperature. (TC1188)



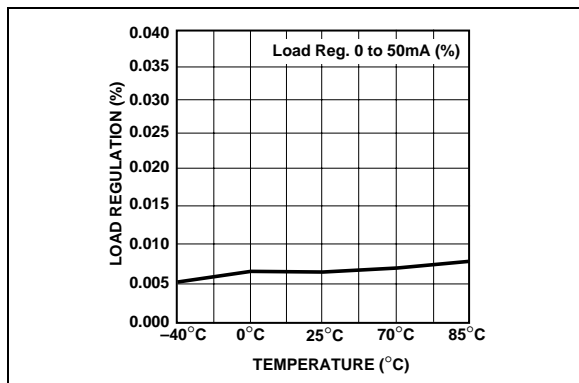
**FIGURE 2-4:** Load Regulation vs. Temperature. (TC1188)



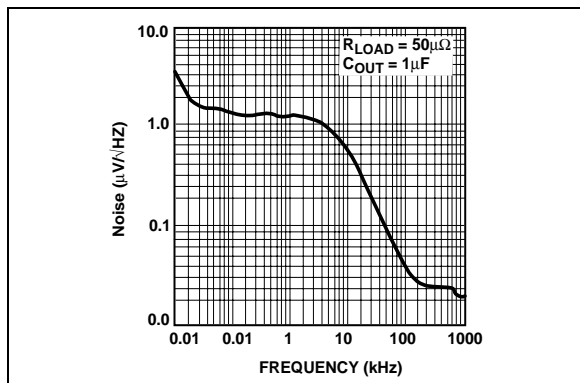
**FIGURE 2-2:** Output Voltage vs. Temperature. (TC1188)



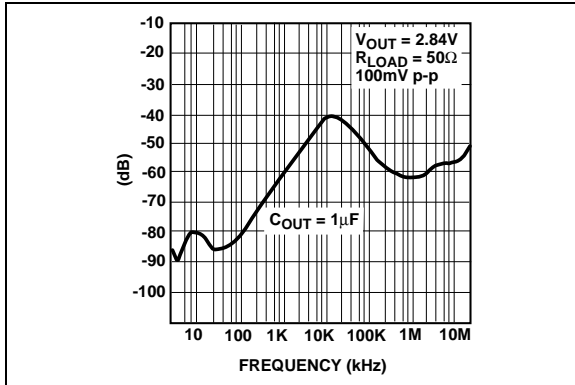
**FIGURE 2-5:** Dropout Voltage vs. Temperature. (TC1188)



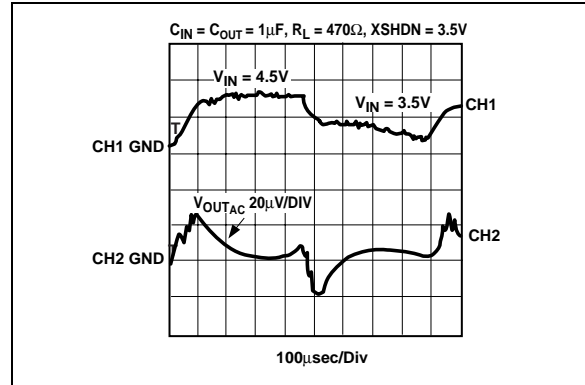
**FIGURE 2-3:** Load Regulation vs. Temperature. (TC1188)



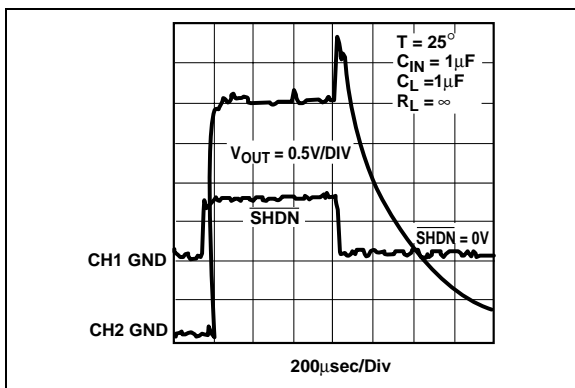
**FIGURE 2-6:** Output Noise vs. Frequency. (TC1188)



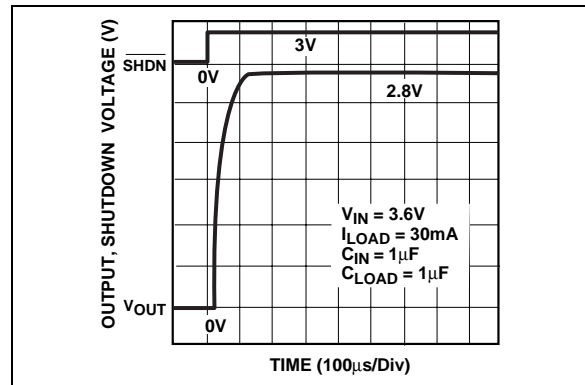
**FIGURE 2-7:** Power Supply Rejection Ratio vs. Frequency. (TC1188)



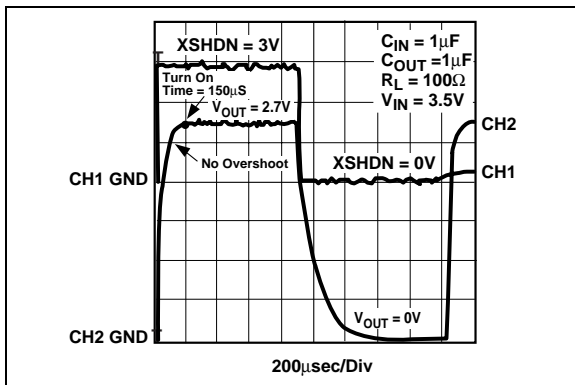
**FIGURE 2-10:** TC1189 Line Response.



**FIGURE 2-8:** TC1189 Shutdown Transient Response.



**FIGURE 2-11:** Wake-Up Response Time.



**FIGURE 2-9:** TC1189 Shutdown Transient Response.

# TC1188/TC1189

## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

**TABLE 3-1: PIN FUNCTION TABLE**

Symbol	Description
SHDN	Active Low Shutdown Input. When the SHDN input is low (< 0.2V), the quiescent current for the TC1188/TC1189 is reduced to 0.1 nA. When the input voltage to the SHDN pin is high (> 2.0V) the output of the TC1188/TC1189 is enabled. For the TC1189 only, the output capacitor is discharged by an internal switch when the SHDN is low.
GND	Ground. Connect to ground.
V <sub>IN</sub>	Unregulated Input Voltage. The input voltage can range from 2.7V to 6.0V.
V <sub>OUT</sub>	Regulator Output. Sources up to 120 mA. Bypass with a 1 μF, <1 Ω typical ESR capacitor to GND.
GND	Connect to GND.

### 3.1 Detailed Description

The TC1188/TC1189 devices are fixed output, low dropout linear regulators. Utilizing CMOS construction, the internal quiescent current consumed by the regulator is minimized when compared to older bipolar low dropout regulators.

The LDO output voltage is sensed at the non-inverting pin of the internal error amplifier. The internal voltage reference is sensed at the inverting pin of the internal error amplifier. The error amplifier adjusts the gate source voltage of the internal P-channel pass device until the divided down output voltage matches the internal reference voltage. When it does, the LDO output voltage is in regulation.

The SHDN, when pulled low, is used to turn off the P-Channel MOSFET and lower the internal quiescent current to less than 1 μA maximum. For normal operation, the SHDN pin is pulled to a high level. (> 2.0V).

The TC1189 incorporates an internal N-Channel MOSFET, which is used to discharge the output capacitor when shutdown. The TC1188 does not have the internal N-Channel MOSFET, therefore, when the device is shutdown, the output voltage will decrease at a rate which is dependant on the load current.

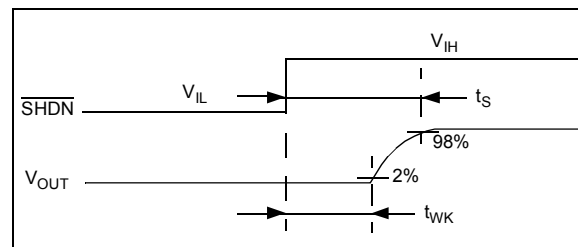
### 3.2 Turn-On Response

The turn-on response is defined as two separate response categories: Wake-Up Time ( $t_{WK}$ ) and Settling Time ( $t_S$ ).

The TC1188/TC1189 have fast wake-up times (10 μsec typical) when released from shutdown. See Figure 3-1 for the wake-up time, designated as  $t_{WK}$ . The wake-up time is defined as the time it takes for the output to rise to 2% of the V<sub>OUT</sub> value after being released from shutdown.

The total turn on response is defined as the Settling Time ( $t_S$ ) (Figure 3-1). Settling Time (inclusive with  $t_{WK}$ ) is defined as the condition when the output is within 2% of its fully enabled value (140 μsec typical) when

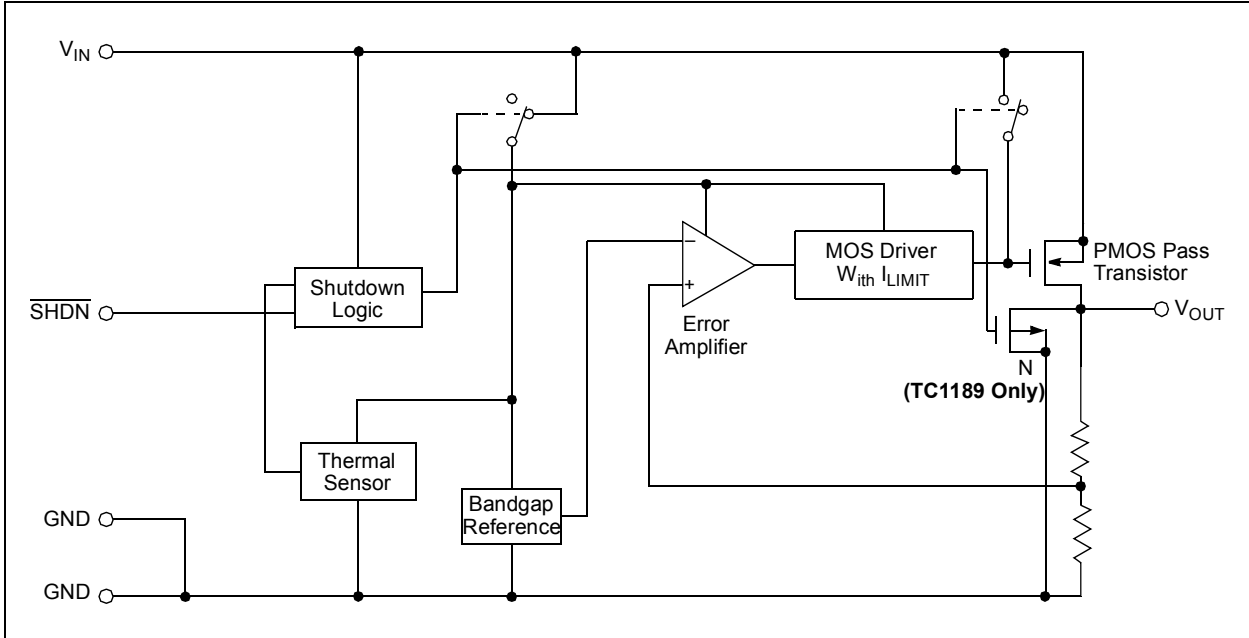
released from shutdown. The settling time of the output voltage is dependent on load conditions and output capacitance on V<sub>OUT</sub> (RC response).



**FIGURE 3-1: Wake-Up Response Time.**

### 3.3 Internal P-Channel Pass Transistor

The Internal P-Channel MOSFET is operated in the linear region to regulate the LDO output voltage. The RDSon of the P-Channel MOSFET is approximately 1.1 Ω, making the LDO able to regulate with little input to output voltage differential, "Low Dropout". Another benefit of using CMOS construction is that the P-Channel MOSFET is a voltage controlled device, so it doesn't consume a fraction of the bias current required of bipolar PNP LDOs.



**FIGURE 3-2:** Functional Block Diagram.

### 3.4 Shutdown

The  $\overline{\text{SHDN}}$  input is used to turn off the LDO P-Channel pass MOSFET and internal bias. When shutdown, the typical quiescent current consumed by the LDO is 0.1 nA. A logic low (< 0.4V) at the  $\overline{\text{SHDN}}$  input will cause the device to operate in the shutdown mode. A logic high (> 2.0V) at the  $\overline{\text{SHDN}}$  input will cause the device to operate in the normal mode.

### 3.5 Current Limit

The LDO output current is monitored internal to the TC1188/TC1189. The internal current sense will limit the LDO output current to a typical value of 280 mA. The current limit can range from approximately 50 mA to 410 mA from device to device. The internal current limit protects the device from a continuous output short circuit.

### 3.6 Thermal Overload Protection

Integrated thermal protection circuitry shuts the TC1188/TC1189 off when the internal die temperature exceeds approximately 170°C. The regulator output remains off until the internal die temperature drops to approximately 150°C.

### 3.7 Operating Region and Power Dissipation

The internal power dissipation to the LDO is primarily determined by the input voltage, output voltage and output current. The following equation is used to approximate the worst case for power dissipation:

#### EQUATION

$$P_D = V_{IN(MAX)} - V_{OUT(MIN)} \times I_{LOAD(MAX)}$$

Where:

$P_D$  = Worst case internal power dissipation.

$V_{IN(MAX)}$  = Maximum input voltage.

$V_{OUT(MIN)}$  = Minimum output voltage.

$I_{LOAD(MAX)}$  = Maximum output current.

The maximum power dissipation is a function of the maximum ambient temperature,  $T_{A(MAX)}$ , the maximum junction temperature,  $T_{J(MAX)}$ , and the package thermal resistance from junction to air,  $\theta_{JA}$ . The 5-Pin SOT23A package has a  $\theta_{JA}$  of approximately 220°C/Watt.

#### EQUATION

$$P_D = (T_{J(MAX)} - T_{A(MAX)})/\theta_{JA}$$

Where all terms are previously defined.

# TC1188/TC1189

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## EXAMPLE 3-1:

The previously defined power dissipation equations can be used to ensure that the regulator thermal operation is within limits.

Given:

$$V_{IN(MAX)} = 3.0V + 10\%$$

$$V_{OUT(MAX)} = 2.7V - 2.5\%$$

$$I_{LOAD(MAX)} = 40 \text{ mA}$$

$$T_{J(MAX)} = 125^{\circ}\text{C}$$

$$T_{A(MAX)} = 55^{\circ}\text{C}$$

## Find:

1. Actual power dissipation.
2. Maximum allowable dissipation.

### Actual power dissipation:

$$P_D = V_{IN(MAX)} - V_{OUT(MIN)} \times I_{LOAD(MAX)}$$
$$P_D = ((3.0 * 1.1) - (2.7 * 0.975)) * 40 \text{ mA}$$
$$P_D = 26.7 \text{ mWatts}$$

### Maximum allowable power dissipation:

$$P_D = (T_{J(MAX)} - T_{A(MAX)}) / \theta_{JA}$$
$$P_{D(MAX)} = (125 - 55) / 220$$
$$P_{D(MAX)} = 318 \text{ mWatts.}$$

In this example, the TC1188/TC1189 dissipates a maximum of 26.7 mW below the allowable limit of 318 mW. In a similar manner, the power dissipation equation, as a function of  $V_{IN}$ ,  $V_{OUT}$  and  $I_{LOAD}$ , along with the power dissipation equation, as a function of maximum junction temperature, maximum ambient temperature and junction to air thermal resistance, can be used to calculate maximum current and/or maximum input voltage limits.

## 4.0 APPLICATIONS INFORMATION

### 4.1 Input Capacitor

A 1  $\mu\text{F}$  (or larger) capacitor is recommended to bypass the LDO input and lower input impedance for circuit stability when operating from batteries or high impedance sources. The input capacitor can be ceramic, tantalum or aluminum electrolytic. For applications that require low noise and input power supply rejection, low effective series resistance (ESR) ceramic capacitors are recommended over higher ESR electrolytic capacitors. Larger value input capacitors can be used to improve circuit performance.

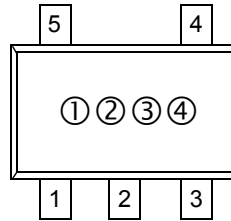
### 4.2 Output Capacitor

A 1  $\mu\text{F}$  (minimum) capacitor is required from  $V_{OUT}$  to ground to ensure circuit stability. The output capacitor should have an ESR greater than 0.1 ohms and less than 2 ohm. Tantalum or aluminum electrolytic capacitors are recommended. Since many aluminum electrolytic capacitors freeze at approximately  $-30^{\circ}\text{C}$ , solid tantalums are recommended for applications operating below  $25^{\circ}\text{C}$ .



## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information



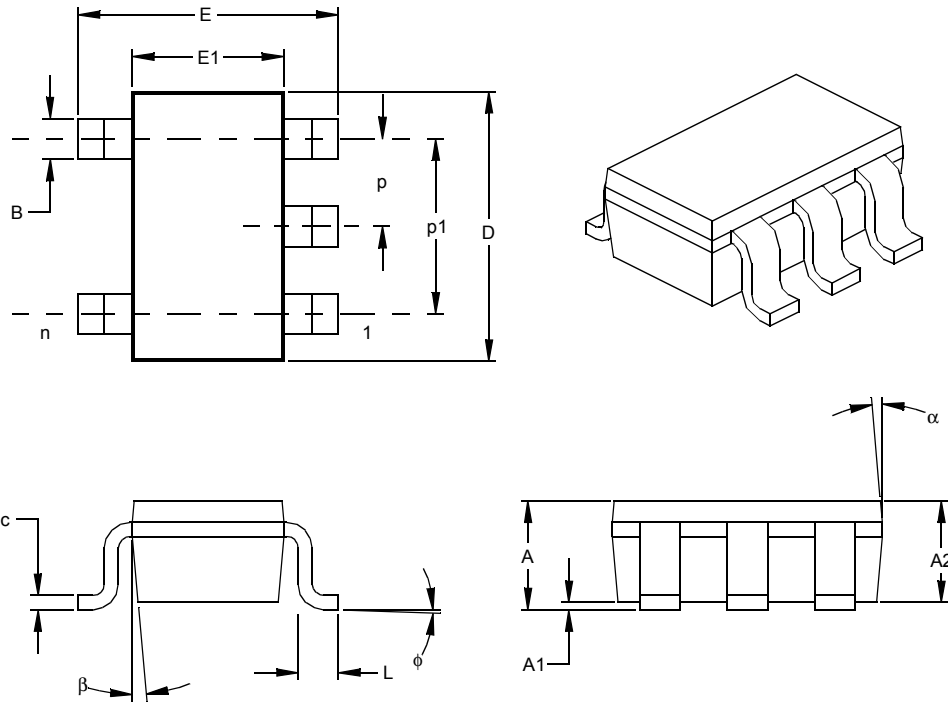
Part Number	(V)	Code
TC1188-XECT	1.80	G4
TC1188-XECT	2.80	G3
TC1188-XECT	2.84	G2
TC1188-XECT	3.15	G1
TC1189-XECT	1.80	H4
TC1189-XECT	2.80	H3
TC1189-XECT	2.84	H2
TC1189-XECT	3.15	H1

<p><b>Legend:</b> 1-2 Part Number code + temperature range and voltage*</p> <p>3 Year and two-month period code</p> <p>4 Lot ID</p>
<p><b>Note:</b> In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.</p>

\* Standard OTP marking consists of Microchip part number, year code, week code, and traceability code.

# TC1188/TC1189

## 5-Lead Plastic Small Outline Transistor (OT) (SOT23)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		5			5	
Pitch	p		.038			0.95	
Outside lead pitch (basic)	p1		.075			1.90	
Overall Height	A	.035	.046	.057	0.90	1.18	1.45
Molded Package Thickness	A2	.035	.043	.051	0.90	1.10	1.30
Standoff §	A1	.000	.003	.006	0.00	0.08	0.15
Overall Width	E	.102	.110	.118	2.60	2.80	3.00
Molded Package Width	E1	.059	.064	.069	1.50	1.63	1.75
Overall Length	D	.110	.116	.122	2.80	2.95	3.10
Foot Length	L	.014	.018	.022	0.35	0.45	0.55
Foot Angle	φ	0	5	10	0	5	10
Lead Thickness	c	.004	.006	.008	0.09	0.15	0.20
Lead Width	B	.014	.017	.020	0.35	0.43	0.50
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

\* Controlling Parameter  
 § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-178

Drawing No. C04-091

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# TC1188/TC1189

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Device: **TC1188/TC1189** Literature Number: **DS21364B**

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2. How does this document meet your hardware and software development needs?

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4. What additions to the data sheet do you think would enhance the structure and subject?

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5. What deletions from the data sheet could be made without affecting the overall usefulness?

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<u>PART NO.</u>	<u>X</u>	<u>/XX</u>	<b>Examples:</b>
Device	Voltage Output	Package	
Device:  Voltage Output Options:  Package:	TC1188: 100 mA, MAX8863/64 Pin Compatible LDO TC1189: 100 mA, MAX8863/64 Pin Compatible LDO  Q = 1.80V R = 2.80V S = 2.84V T = 3.15V	ECTTR = SOT-23A, 5-Pin (Tape and Reel)	a) TC1188QECTTR: 1.80V, 100 mA, MAX8863/64 Pin Compatible LDO b) TC1188RECTTR: 2.80V, 100 mA, MAX8863/64 Pin Compatible LDO c) TC1188SECTTR: 2.84V, 100 mA, MAX8863/64 Pin Compatible LDO d) TC1188TECTTR: 3.15V, 100 mA, MAX8863/64 Pin Compatible LDO  a) TC1189QECTTR: 1.80V, 100 mA, MAX8863/64 Pin Compatible LDO b) TC1189RECTTR: 2.80V, 100 mA, MAX8863/64 Pin Compatible LDO c) TC1189SECTTR: 2.84V, 100 mA, MAX8863/64 Pin Compatible LDO d) TC1189TECTTR: 3.15V, 100 mA, MAX8863/64 Pin Compatible LDO

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# TC1188/TC1189

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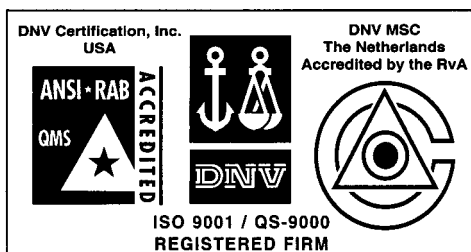
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Web Address: <http://www.microchip.com>

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Tel: 631-273-5305 Fax: 631-273-5335

#### San Jose

Microchip Technology Inc.  
2107 North First Street, Suite 590  
San Jose, CA 95131  
Tel: 408-436-7950 Fax: 408-436-7955

#### Toronto

6285 Northam Drive, Suite 108  
Mississauga, Ontario L4V 1X5, Canada  
Tel: 905-673-0699 Fax: 905-673-6509

### ASIA/PACIFIC

#### Australia

Microchip Technology Australia Pty Ltd  
Suite 22, 41 Rawson Street  
Epping 2121, NSW  
Australia  
Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

#### China - Beijing

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Beijing Liaison Office  
Unit 915  
Bei Hai Wan Tai Bldg.  
No. 6 Chaoyangmen Beidajie  
Beijing, 100027, No. China  
Tel: 86-10-85282100 Fax: 86-10-85282104

#### China - Chengdu

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Co., Ltd., Chengdu Liaison Office  
Rm. 2401, 24th Floor,  
Ming Xing Financial Tower  
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Chengdu 610016, China  
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Microchip Technology Consulting (Shanghai)  
Co., Ltd.  
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Far East International Plaza  
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Shanghai, 200051  
Tel: 86-21-6275-5700 Fax: 86-21-6275-5060

#### China - Shenzhen

Microchip Technology Consulting (Shanghai)  
Co., Ltd., Shenzhen Liaison Office  
Rm. 1315, 13/F, Shenzhen Kerry Centre,  
Renminnan Lu  
Shenzhen 518001, China  
Tel: 86-755-2350361 Fax: 86-755-2366086

#### China - Hong Kong SAR

Microchip Technology Hongkong Ltd.  
Unit 901-6, Tower 2, Metroplaza  
223 Hing Fong Road  
Kwai Fong, N.T., Hong Kong  
Tel: 852-2401-1200 Fax: 852-2401-3431

#### India

Microchip Technology Inc.  
India Liaison Office  
Divyasree Chambers  
1 Floor, Wing A (A3/A4)  
No. 11, O'Shaughnessey Road  
Bangalore, 560 025, India  
Tel: 91-80-2290061 Fax: 91-80-2290062

### Japan

Microchip Technology Japan K.K.  
Benex S-1 6F  
3-18-20, Shinyokohama  
Kohoku-Ku, Yokohama-shi  
Kanagawa, 222-0033, Japan  
Tel: 81-45-471-6166 Fax: 81-45-471-6122

### Korea

Microchip Technology Korea  
168-1, Youngbo Bldg. 3 Floor  
Samsung-Dong, Kangnam-Ku  
Seoul, Korea 135-882  
Tel: 82-2-554-7200 Fax: 82-2-558-5934

### Singapore

Microchip Technology Singapore Pte Ltd.  
200 Middle Road  
#07-02 Prime Centre  
Singapore, 188980  
Tel: 65-6334-8870 Fax: 65-6334-8850

### Taiwan

Microchip Technology (Barbados) Inc.,  
Taiwan Branch  
11F-3, No. 207  
Tung Hua North Road  
Taipei, 105, Taiwan  
Tel: 886-2-2717-7175 Fax: 886-2-2545-0139

### EUROPE

#### Denmark

Microchip Technology Nordic ApS  
Regus Business Centre  
Lautrup høj 1-3  
Ballerup DK-2750 Denmark  
Tel: 45 4420 9895 Fax: 45 4420 9910

#### France

Microchip Technology SARL  
Parc d'Activite du Moulin de Massy  
43 Rue du Saule Trapu  
Batiment A - 1er Etage  
91300 Massy, France  
Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

#### Germany

Microchip Technology GmbH  
Gustav-Heinemann Ring 125  
D-81739 Munich, Germany  
Tel: 49-89-627-144 0 Fax: 49-89-627-144-44

#### Italy

Microchip Technology SRL  
Centro Direzionale Colleoni  
Palazzo Taurus 1 V. Le Colleoni 1  
20041 Agrate Brianza  
Milan, Italy  
Tel: 39-039-65791-1 Fax: 39-039-6899883

#### United Kingdom

Microchip Ltd.  
505 Eskdale Road  
Winnersh Triangle  
Wokingham  
Berkshire, England RG41 5TU  
Tel: 44 118 921 5869 Fax: 44-118 921-5820

#### Austria

Microchip Technology Austria GmbH  
Durisolstrasse 2  
A-4600 Wels  
Austria  
Tel: 43-7242-2244-399  
Fax: 43-7242-2244-393

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